


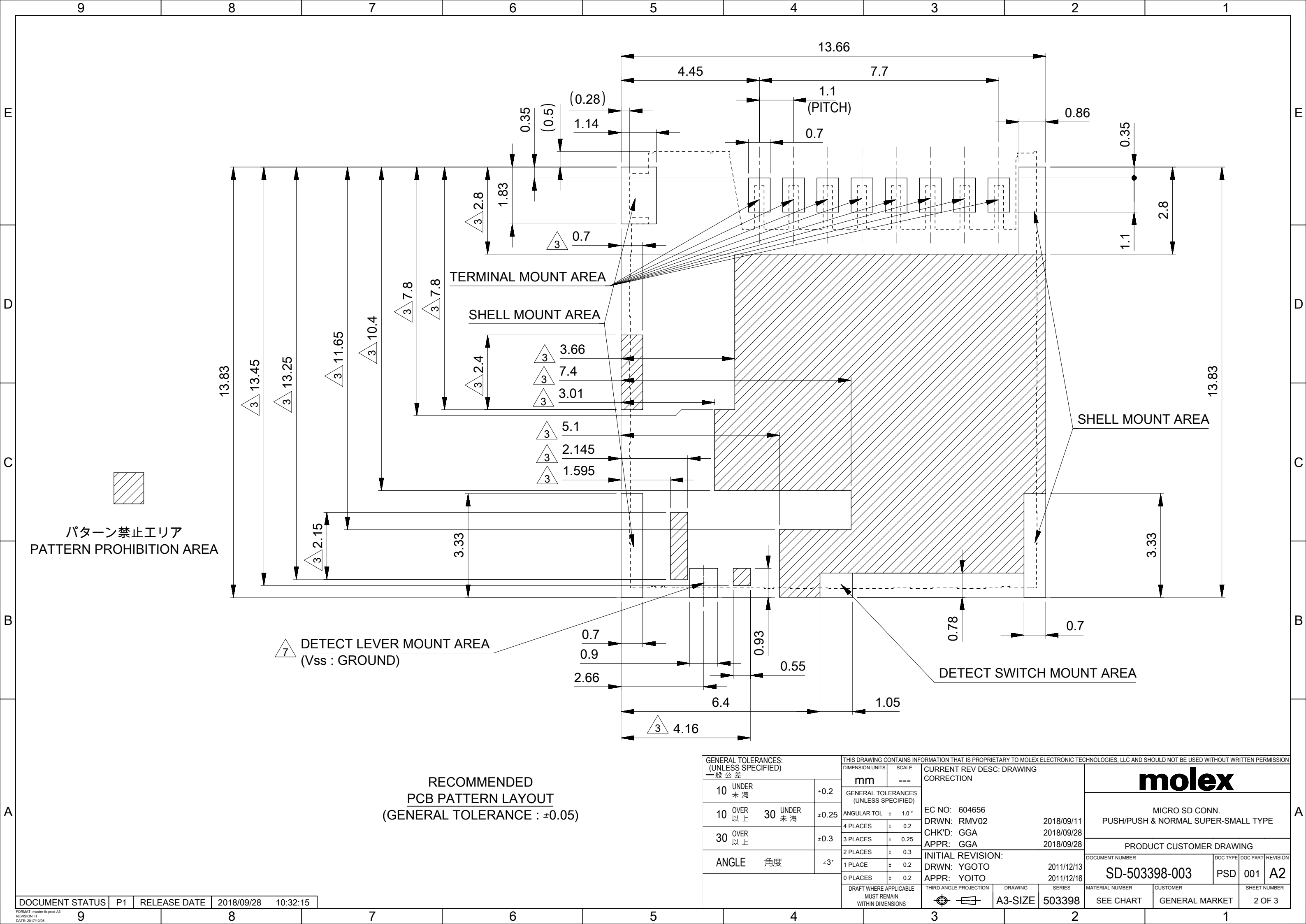
- NOTES:
- 1.ターミナル及びネイルの平坦度は0.1 MAX.
(測定用定板面を基準)
2.スタンドオフ寸法 STAND OFF
3.パターン禁止エリア PATTERN PROHIBITION AREA
4.カード検知スイッチ DETECT SWITCH
 - 5.肉抜き位置は任意とする。CAVITY IS TO BE OPTIONAL.
 - 6.ロット印字は任意とする。LOT NUMBERING IS TO BE OPTIONAL.
 - 7.GND 推奨パターン GND RECOMMENDED PATTERN.
 - 8.ELV 及びRoHS適合品 ELV AND RoHS COMPLIANT.
 - 9.カード裏挿し誤挿入時、カード突出エリア
(他の部品の設置、非推奨範囲)
WHEN A CARD IS MISS-MATED IN THE REVERSE ORIENTATION,
PART OF THE CARD PROTRUDES FROM THE SHELL DUE TO
THE CARD-MISS MATING PREVENTION FEATURE.
THEREFORE, NO COMPONENTS ARE ALLOWED TO BE PLACED IN THIS AREA.
 - 10.本製品はカード排出性向上品です。
This product is card ejection performance improvement type.

カード挿入時 CARD INSERTING POSITION	クローズ CLOSE
カード未挿入時 NO CARD	オープン OPEN

503398-1892	8
EMBOSSED PACKAGE	極数
オーダー番号 ORDER NO.	CIRCUITS
CONNECTOR SERIES No.	503398-1821


GENERAL TOLERANCES: (UNLESS SPECIFIED) 一般公差			THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION															
			DIMENSION UNITS		SCALE		CURRENT REV DESC: DRAWING CORRECTION				<div>molex</div>							
			mm		---													
10 UNDER 未満			±0.2		GENERAL TOLERANCES (UNLESS SPECIFIED)				MICRO SD CONN. PUSH/PUSH & NORMAL SUPER-SMALL TYPE									
10 OVER 以上			30 UNDER 未満										±0.25					
30 OVER 以上			±0.3		ANGULAR TOL ± 1.0 °				EC NO: 604656									
ANGLE 角度			±3°		4 PLACES		± 0.2		DRWN: RMV02 2018/09/11									
					3 PLACES		± 0.25		CHK'D: GGA 2018/09/28									
					2 PLACES		± 0.3		APPR: GGA 2018/09/28									
					1 PLACE		± 0.2		INITIAL REVISION:									
					0 PLACES		± 0.2		DRWN: YGOTO 2011/12/13									
					DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS				APPR: YOITO 2011/12/16									
					THIRD ANGLE PROJECTION		DRAWING		SERIES		DOCUMENT NUMBER		DOC TYPE		DOC PART		REVISION	
							A3-SIZE		503398		SD-503398-003		PSD		001		A2	
											MATERIAL NUMBER		CUSTOMER				SHEET NUMBER	
											SEE CHART		GENERAL MARKET				1 OF 3	

DOCUMENT STATUS	P1	RELEASE DATE	2018/09/28	10:32:15
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パターン禁止エリア
PATTERN PROHIBITION AREA

RECOMMENDED
PCB PATTERN LAYOUT
(GENERAL TOLERANCE : ±0.05)

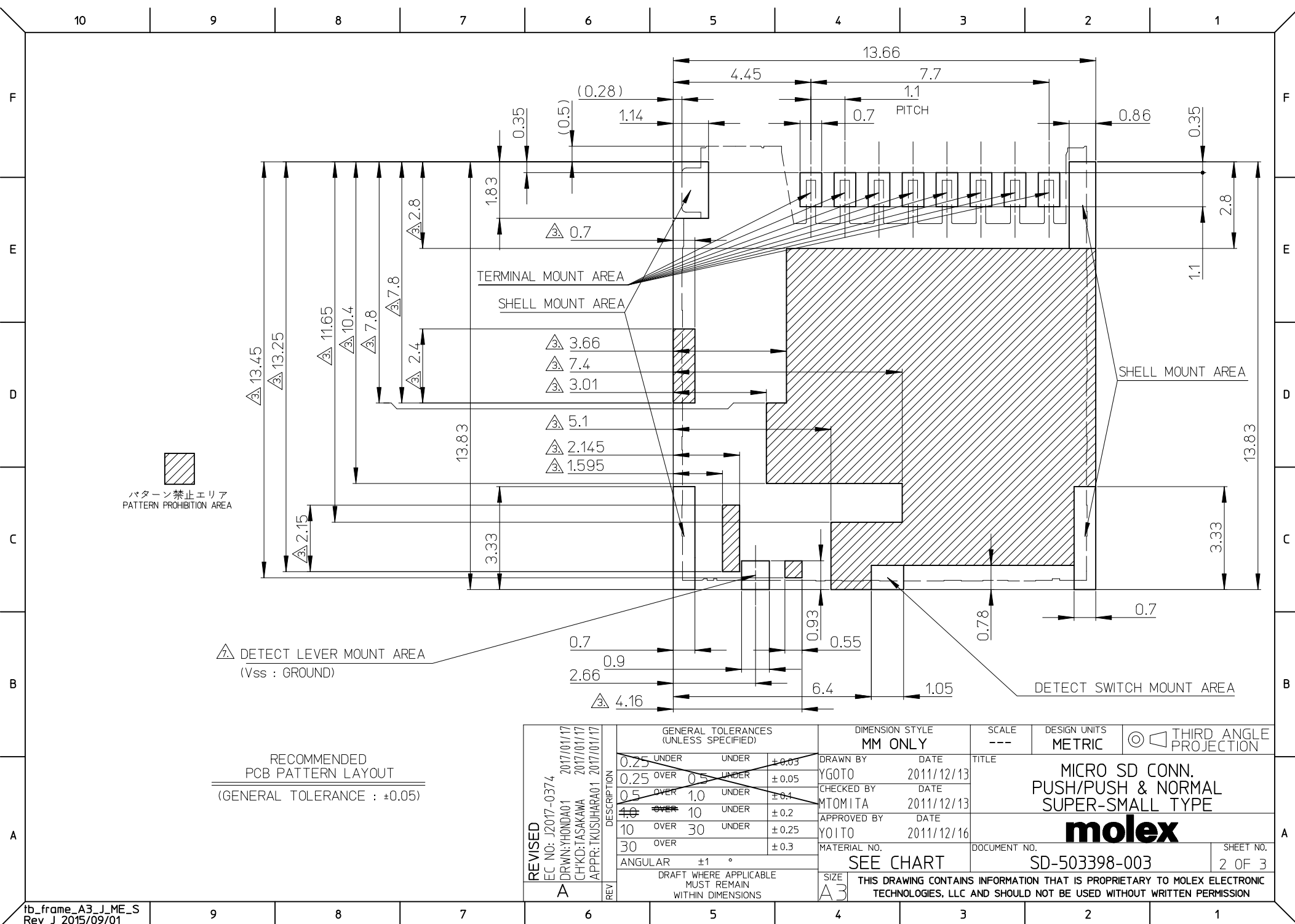
GENERAL TOLERANCES: (UNLESS SPECIFIED) 一般公差			THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION											
			DIMENSION UNITS		SCALE		CURRENT REV DESC: DRAWING CORRECTION				<div>molex</div> <div>MICRO SD CONN. PUSH/PUSH & NORMAL SUPER-SMALL TYPE</div>			
			mm	---										
			GENERAL TOLERANCES (UNLESS SPECIFIED)			EC NO: 604656 DRWN: RMV02 2018/09/11 CHK'D: GGA 2018/09/28 APPR: GGA 2018/09/28				PRODUCT CUSTOMER DRAWING				
			ANGULAR TOL ± 1.0 °											
			4 PLACES ± 0.2											
			3 PLACES ± 0.25											
			2 PLACES ± 0.3		INITIAL REVISION: DRWN: YGOTO 2011/12/13 APPR: YOITO 2011/12/16				DOCUMENT NUMBER		DOC TYPE	DOC PART	REVISION	
			1 PLACE ± 0.2						SD-503398-003		PSD	001	A2	
			0 PLACES ± 0.2		THIRD ANGLE PROJECTION		DRAWING	SERIES	MATERIAL NUMBER		CUSTOMER		SHEET NUMBER	
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS				A3-SIZE	503398	SEE CHART		GENERAL MARKET		2 OF 3	

DOCUMENT STATUS	P1	RELEASE DATE	2018/09/28	10:32:15
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FORMAT: master-b-prod-A3
REVISION: 14
DATE: 201710/06

9		8		7		6		5		4		3		2		1																																					
<table><tr><td>番号 NO.</td><td>名 称 NAME</td><td>材 料 MATERIAL</td><td>仕 上 げ (め っ き) FINISHES (PLATING)</td></tr><tr><td>1</td><td>ハウジング HOUSING</td><td>液晶ポリマー(LCP)、ガラス充填、UL94 V-0、黒 LIQUID CRYSTAL POLYMER (LCP), GLASS FILLED, UL94 V-0, BLACK ポリプラスチック製VECTRA S475 VECTRA S475 MADE OF POLYPLASTICS</td><td></td></tr><tr><td>2</td><td>カムスライダー CAM SLIDER</td><td>液晶ポリマー(LCP)、ガラス充填、UL94 V-0、黒 LIQUID CRYSTAL POLYMER (LCP), GLASS FILLED, UL94 V-0, BLACK ポリプラスチック製 VECTRA E130i VECTRA E130i MADE OF POLYPLASTICS</td><td></td></tr><tr><td>3</td><td>ターミナル TERMINAL</td><td>燐青銅 C52100(t=0.15) PHOSPOHR BRONZE C52100(t=0.15)</td><td>接触部：金めっき (0.5μm MIN.) テール部：錫めっき (2.0μm MIN.) 下地：ニッケルめっき (1.0μm MIN.) CONTACT AREA：GOLD PLATING (0.5 MICROMETER MINIMUM.) SOLDER TAIL AREA：TIN PLATING (2.0 MICROMETER MINIMUM.) UNDERPLATE：NICKEL OVERALL (1.0 MICROMETER MINIMUM.)</td></tr><tr><td>4</td><td>シェル SHELL</td><td>ステンレス鋼 SUS301(t=0.1) STAINLESS STEEL SUS301(t=0.1)</td><td>基板実装部：金めっき (0.02μm MIN.) 下地：ニッケルめっき (0.5μm MIN.) NAIL AREA：GOLD PLATING (0.02 MICROMETER MINIMUM.) UNDERPLATE：NICKEL OVERALL (0.5 MICROMETER MINIMUM.)</td></tr><tr><td>5</td><td>スプリング SPRING</td><td>ピアノ線 SWP</td><td>全面：ニッケルめっき (3.0μm MIN.) NICKEL OVERALL (3.0 MICROMETER MINIMUM.)</td></tr><tr><td>6</td><td>ピン PIN</td><td>ステンレス鋼 SUS304 STAINLESS STEEL SUS304</td><td></td></tr><tr><td>7</td><td>ディテクト レバー DETECT LEVER</td><td>燐青銅 C52100(t=0.15) PHOSPOHR BRONZE C52100(t=0.15)</td><td>接触部：金めっき (0.2μm MIN.) 基板実装部：金めっき 下地：ニッケルめっき CONTACT AREA：GOLD PLATING (0.2 MICROMETER MINIMUM.) NAIL AREA：GOLD PLATING UNDERPLATE：NICKEL OVERALL</td></tr><tr><td>8</td><td>ディテクト スイッチ DETECT SWITCH</td><td>燐青銅 C52100(t=0.15) PHOSPOHR BRONZE C52100(t=0.15)</td><td>接触部：金めっき (0.2μm MIN.) 基板実装部：金めっき 下地：ニッケルめっき CONTACT AREA：GOLD PLATING (0.2 MICROMETER MINIMUM.) NAIL AREA：GOLD PLATING UNDERPLATE：NICKEL OVERALL</td></tr></table>																		番号 NO.	名 称 NAME	材 料 MATERIAL	仕 上 げ (め っ き) FINISHES (PLATING)	1	ハウジング HOUSING	液晶ポリマー(LCP)、ガラス充填、UL94 V-0、黒 LIQUID CRYSTAL POLYMER (LCP), GLASS FILLED, UL94 V-0, BLACK ポリプラスチック製VECTRA S475 VECTRA S475 MADE OF POLYPLASTICS		2	カムスライダー CAM SLIDER	液晶ポリマー(LCP)、ガラス充填、UL94 V-0、黒 LIQUID CRYSTAL POLYMER (LCP), GLASS FILLED, UL94 V-0, BLACK ポリプラスチック製 VECTRA E130i VECTRA E130i MADE OF POLYPLASTICS		3	ターミナル TERMINAL	燐青銅 C52100(t=0.15) PHOSPOHR BRONZE C52100(t=0.15)	接触部：金めっき (0.5μm MIN.) テール部：錫めっき (2.0μm MIN.) 下地：ニッケルめっき (1.0μm MIN.) CONTACT AREA：GOLD PLATING (0.5 MICROMETER MINIMUM.) SOLDER TAIL AREA：TIN PLATING (2.0 MICROMETER MINIMUM.) UNDERPLATE：NICKEL OVERALL (1.0 MICROMETER MINIMUM.)	4	シェル SHELL	ステンレス鋼 SUS301(t=0.1) STAINLESS STEEL SUS301(t=0.1)	基板実装部：金めっき (0.02μm MIN.) 下地：ニッケルめっき (0.5μm MIN.) NAIL AREA：GOLD PLATING (0.02 MICROMETER MINIMUM.) UNDERPLATE：NICKEL OVERALL (0.5 MICROMETER MINIMUM.)	5	スプリング SPRING	ピアノ線 SWP	全面：ニッケルめっき (3.0μm MIN.) NICKEL OVERALL (3.0 MICROMETER MINIMUM.)	6	ピン PIN	ステンレス鋼 SUS304 STAINLESS STEEL SUS304		7	ディテクト レバー DETECT LEVER	燐青銅 C52100(t=0.15) PHOSPOHR BRONZE C52100(t=0.15)	接触部：金めっき (0.2μm MIN.) 基板実装部：金めっき 下地：ニッケルめっき CONTACT AREA：GOLD PLATING (0.2 MICROMETER MINIMUM.) NAIL AREA：GOLD PLATING UNDERPLATE：NICKEL OVERALL	8	ディテクト スイッチ DETECT SWITCH	燐青銅 C52100(t=0.15) PHOSPOHR BRONZE C52100(t=0.15)	接触部：金めっき (0.2μm MIN.) 基板実装部：金めっき 下地：ニッケルめっき CONTACT AREA：GOLD PLATING (0.2 MICROMETER MINIMUM.) NAIL AREA：GOLD PLATING UNDERPLATE：NICKEL OVERALL
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GENERAL TOLERANCES: (UNLESS SPECIFIED) 一般公差		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION	
10 UNDER 未 満		±0.2	DIMENSION UNITS mm
10 OVER 以 上		30 UNDER 未 満	±0.25
30 OVER 以 上		±0.3	SCALE ---
ANGLE		角度	±3°
			GENERAL TOLERANCES (UNLESS SPECIFIED)
			ANGULAR TOL ± 1.0 °
			4 PLACES ± 0.2
			3 PLACES ± 0.25
			2 PLACES ± 0.3
			1 PLACE ± 0.2
			0 PLACES ± 0.2
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS
			CURRENT REV DESC: DRAWING CORRECTION
			EC NO: 604656
			DRWN: RMV02 2018/09/11
			CHK'D: GGA 2018/09/28
			APPR: GGA 2018/09/28
			INITIAL REVISION:
			DRWN: YGOTO 2011/12/13
			APPR: YOITO 2011/12/16
			THIRD ANGLE PROJECTION
			DRAWING
			SERIES
			MATERIAL NUMBER
			CUSTOMER
			SHEET NUMBER
			A3-SIZE
			503398
			SEE CHART
			GENERAL MARKET
			3 OF 3



F

E

D

C

B

A

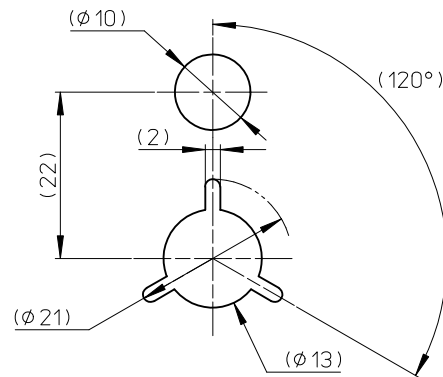
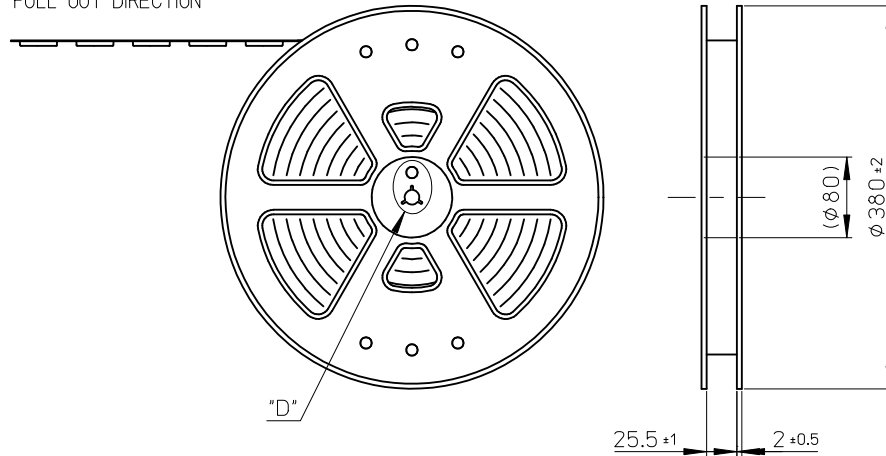
番号 NO.	名 称 NAME	材 料 MATERIAL	仕上げ（めっき） FINISHES (PLATING)
①	ハウジング HOUSING	液晶ポリマー(LCP)、ガラス充填、UL94 V-0、黒 LIQUID CRYSTAL POLYMER (LCP), GLASS FILLED, UL94 V-0, BLACK ポリプラスチック製 VECTRA S475 VECTRA S475 MADE OF POLYPLASTICS	
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③	ターミナル TERMINAL	燐青銅 C52100(t=0.15) PHOSPHOR BRONZE C52100(t=0.15)	接触部：金めっき (0.5μm MIN.) テール部：錫めっき (2.0μm MIN.) 下地：ニッケルめっき (1.0μm MIN.) CONTACT AREA:GOLD PLATING (0.5 MICROMETER MINIMUM.) SOLDER TAIL AREA:TIN PLATING (2.0 MICROMETER MINIMUM.) UNDERPLATE:NICKEL OVERALL (1.0 MICROMETER MINIMUM.)
④	シェル SHELL	ステンレス鋼 SUS301(t=0.1) STAINLESS STEEL SUS301(t=0.1)	基板実装部：金めっき (0.02μm MIN.) 下地：ニッケルめっき (0.5μm MIN.) NAIL AREA:GOLD PLATING (0.02 MICROMETER MINIMUM.) UNDERPLATE:NICKEL OVERALL (0.5 MICROMETER MINIMUM.)
⑤	スプリング SPRING	ピアノ線 SWP	全面：ニッケルめっき (3.0μm MIN.) NICKEL OVERALL (3.0 MICROMETER MINIMUM.)
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⑦	ディテクト レバー DETECT LEVER	燐青銅 C52100(t=0.15) PHOSPHOR BRONZE C52100(t=0.15)	接触部：金めっき (0.2μm MIN.) 基板実装部：金めっき 下地：ニッケルめっき CONTACT AREA:GOLD PLATING (0.2 MICROMETER MINIMUM.) NAIL AREA:GOLD PLATING UNDERPLATE:NICKEL OVERALL
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REVISED EC NO: J2017-0374 DRWN:YHONDA01 2017/01/17 CHKD:TASAKAWA 2017/01/17 APPR:TKUSUHARA01 2017/01/17 A		DESCRIPTION REV	GENERAL TOLERANCES (UNLESS SPECIFIED)			DIMENSION STYLE MM ONLY		SCALE 1:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
			0.25 UNDER UNDER ±0.03			DRAWN BY DATE		TITLE MICRO SD CONN. PUSH/PUSH & NORMAL SUPER-SMALL TYPE				
			0.25 OVER 0.5 UNDER ±0.05			YGOTO 2011/12/13						
			0.5 OVER 1.0 UNDER ±0.1			CHECKED BY DATE						
			1.0 OVER 10 UNDER ±0.2			MTOMITA 2011/12/13						
10 OVER 30 UNDER ±0.25			APPROVED BY DATE		molex							
30 OVER ±0.3			YOITO 2011/12/16									
ANGULAR ±1 °			MATERIAL NO.		DOCUMENT NO.		SD-503398-003		SHEET NO. 3 OF 3			
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							

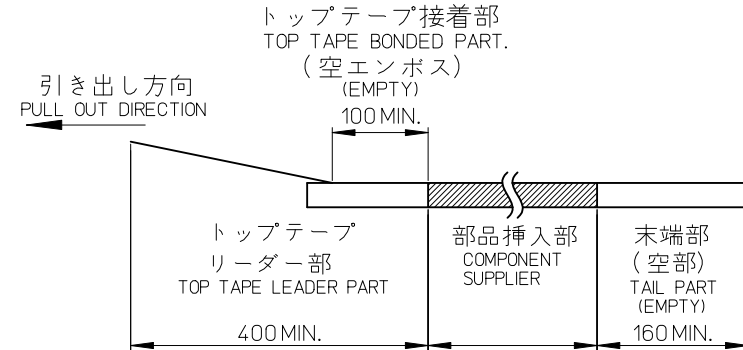
NOTES

- 製品詳細寸法については、SD 図面を参照下さい。
RE DETAILED DIMENSION, SEE SALES DRAWING.
- 梱包数量: 2400個/リール
NUMBER OF CONNECTORS: 2400 PCS/REEL.
- リードテープ長さ LEAD TAPE LENGTH.

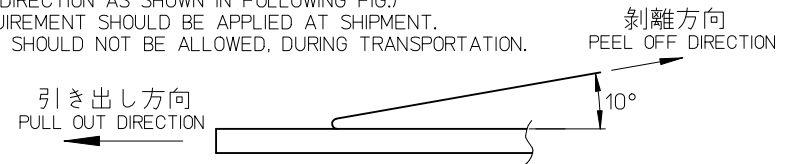
引き出し方向
PULL OUT DIRECTION



DETAIL "D"





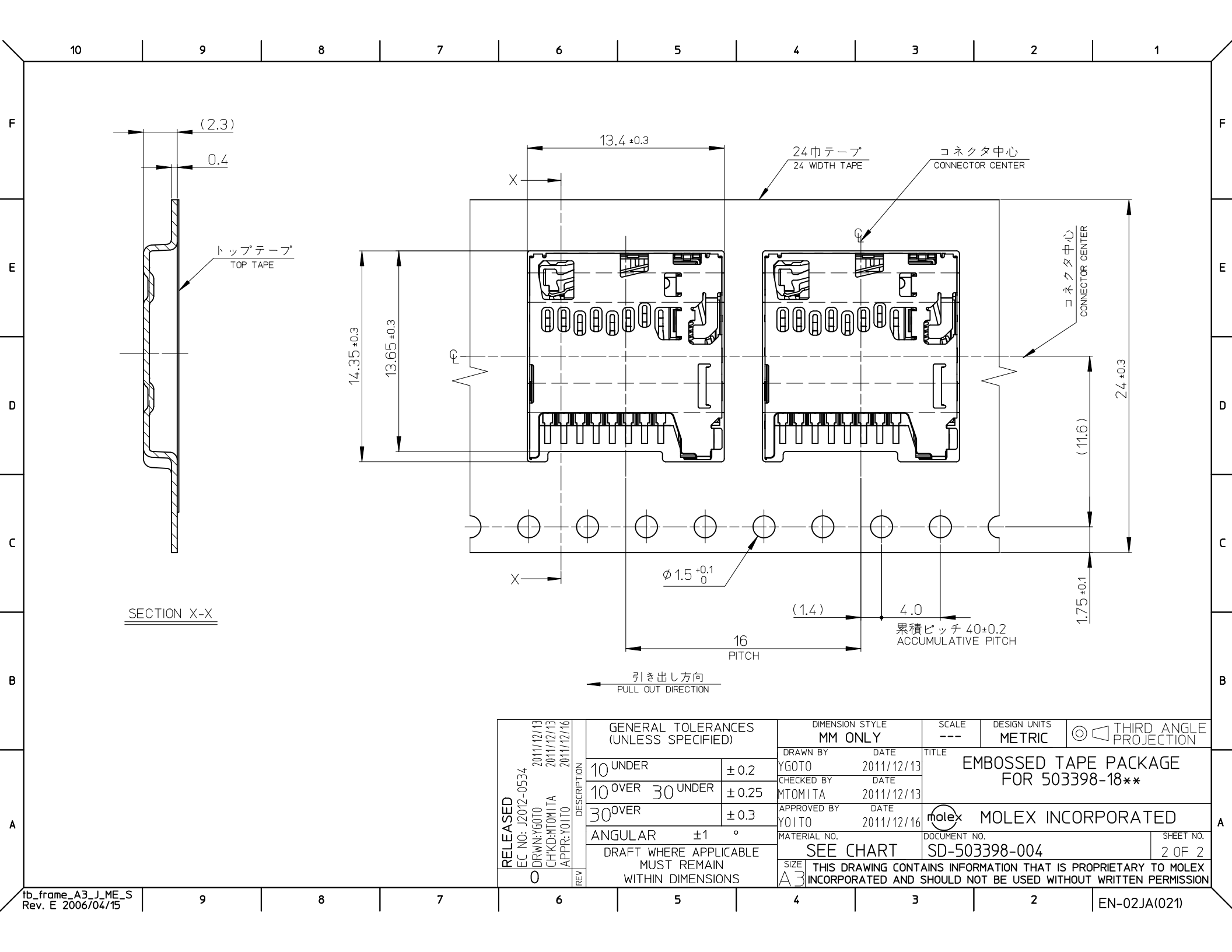
- トップテープの剥離強度: JIS C0806-3に準拠(剥離方向は下図参照)
尚、本規格値は出荷時に適用。(但し、輸送時に剥離が発生しないこと。)
PEELING OFF FORCE OF TOP TAPE: BASED UPON JIS C0806-3
(PEELING DIRECTION AS SHOWN IN FOLLOWING FIG.)
THIS REQUIREMENT SHOULD BE APPLIED AT SHIPMENT.
PEEL OFF SHOULD NOT BE ALLOWED, DURING TRANSPORTATION.



- 材料 MATERIAL
キャリアテープ (CARRIER TAPE): ポリスチレン (POLYSTYRENE)
トップテープ (TOP TAPE): PET, PE, PEF
リール (REEL): ポリスチレン (PS) <リサイクル材含む>
POLYSTYRENE (PS) <RECYCLE MATERIAL CONTAINED>

503398-1892	8
EMBOSSED PACKAGE	極数
オーダー番号 ORDER NO.	CIRCUITS
CONNECTOR SERIES No. 503398-1821	

RELEASED EC NO: J2012-0534 DRAWN: YGOTO CHKD: MTOMITA APPR: YOITO	2011/12/13	2011/12/13	2011/12/16	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 1:1	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION			
					10 UNDER	± 0.2	DRAWN BY YGOTO	DATE 2011/12/13	TITLE EMBOSSED TAPE PACKAGE FOR 503398-18**					
					10 OVER 30 UNDER	± 0.25	CHECKED BY MTOMITA	DATE 2011/12/13						
					30 OVER	± 0.3	APPROVED BY YOITO	DATE 2011/12/16	 MOLEX INCORPORATED					
					ANGULAR ±1 °		MATERIAL NO.					DOCUMENT NO.		SHEET NO.
					DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART					SD-503398-004		1 OF 2
							SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						



SECTION X-X

RELEASED EC NO: J2012-0534 DRWN: YGOTO CHKD: MTOMITA APPR: Y01TO REV: 0	DESCRIPTION 2011/12/13 2011/12/13 2011/12/16	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	± 0.2	DRAWN BY YGOTO	DATE 2011/12/13	TITLE EMBOSSD TAPE PACKAGE FOR 503398-18**				
		10 OVER 30 UNDER	± 0.25	CHECKED BY MTOMITA	DATE 2011/12/13					
		30 OVER	± 0.3	APPROVED BY Y01TO	DATE 2011/12/16	MOLEX MOLEX INCORPORATED				
		ANGULAR ±1 °		MATERIAL NO.		DOCUMENT NO.				SHEET NO.
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		SD-503398-004				2 OF 2
				SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					